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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, I <sup>2</sup> C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, Voltage Detect, WDT
Number of I/O	41
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21236dfp-u0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21236dfp-u0</a>

## **1. Overview**

This MCU is built using the high-performance silicon gate CMOS process using the R8C CPU core and is packaged in a 48-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1 Mbyte of address space, it is capable of executing instructions at high speed. This MCU is equipped with one CAN module and suited to in-vehicle or FA networking.

Furthermore, the data flash (1 KB x 2 blocks) is embedded in the R8C/23 Group.

The difference between R8C/22 and R8C/23 Groups is only the existence of the data flash. Their peripheral functions are the same.

### **1.1 Applications**

Automotive, etc.

Table 1.4 Product Information for R8C/23 Group

Current of Aug. 2008

Type No.	ROM Capacity		RAM Capacity	Package Type	Remarks	
	Program ROM	Data Flash				
R5F21236DFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	D version	Flash memory version
R5F21237DFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238DFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F21236JFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	J version	
R5F21237JFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238JFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AJFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A	K version	
R5F2123CJFP	128 Kbytes <sup>(1)</sup>	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		
R5F21236KFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A		
R5F21237KFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238KFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AKFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CKFP	128 Kbytes <sup>(1)</sup>	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		

## NOTE:

- Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

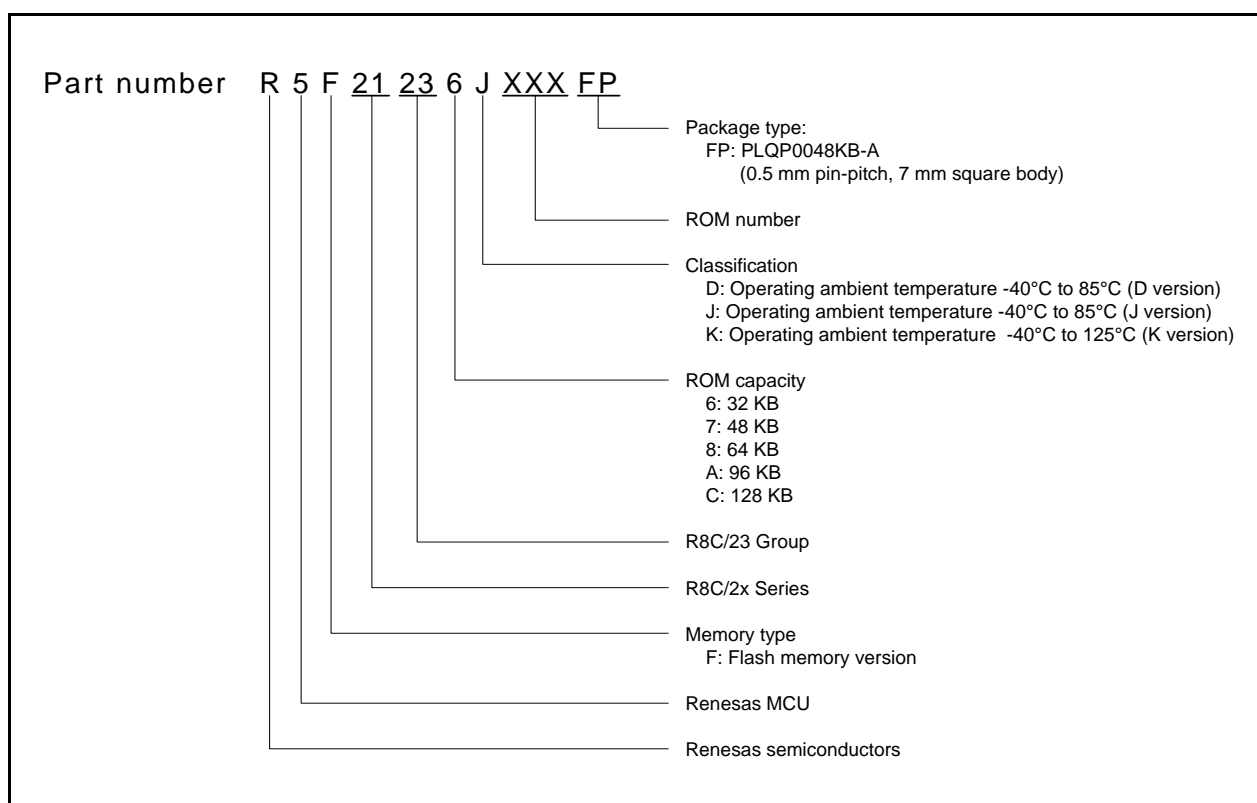


Figure 1.3 Type Number, Memory Size, and Package of R8C/23 Group

### 3. Memory

#### 3.1 R8C/22 Group

Figure 3.1 shows a Memory Map of R8C/22 Group. The R8C/22 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

The internal ROM is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future user and cannot be accessed by users.

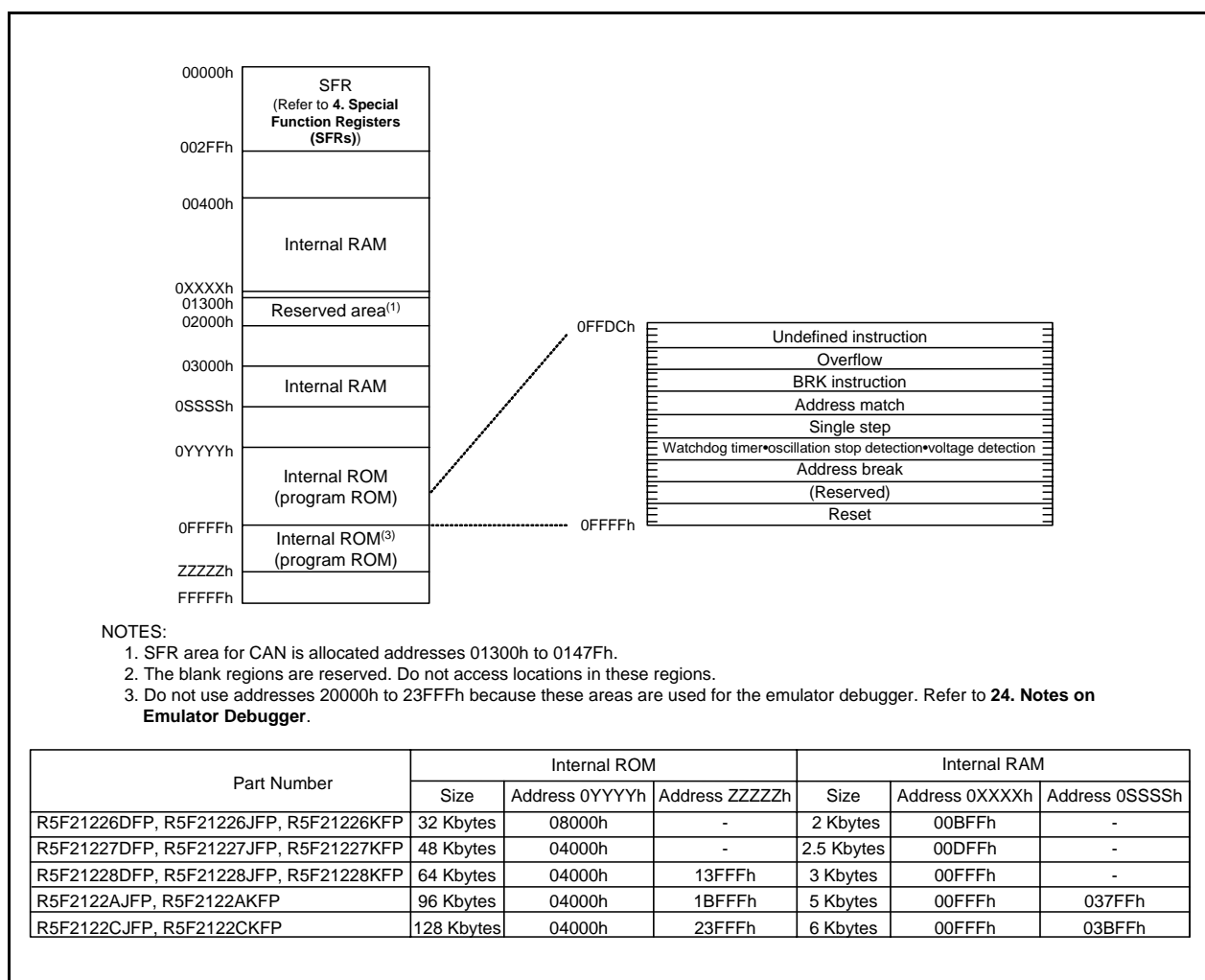


Figure 3.1 Memory Map of R8C/22 Group

### 3.2 R8C/23 Group

Figure 3.2 shows a Memory Map of R8C/23 Group. The R8C/23 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated them. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

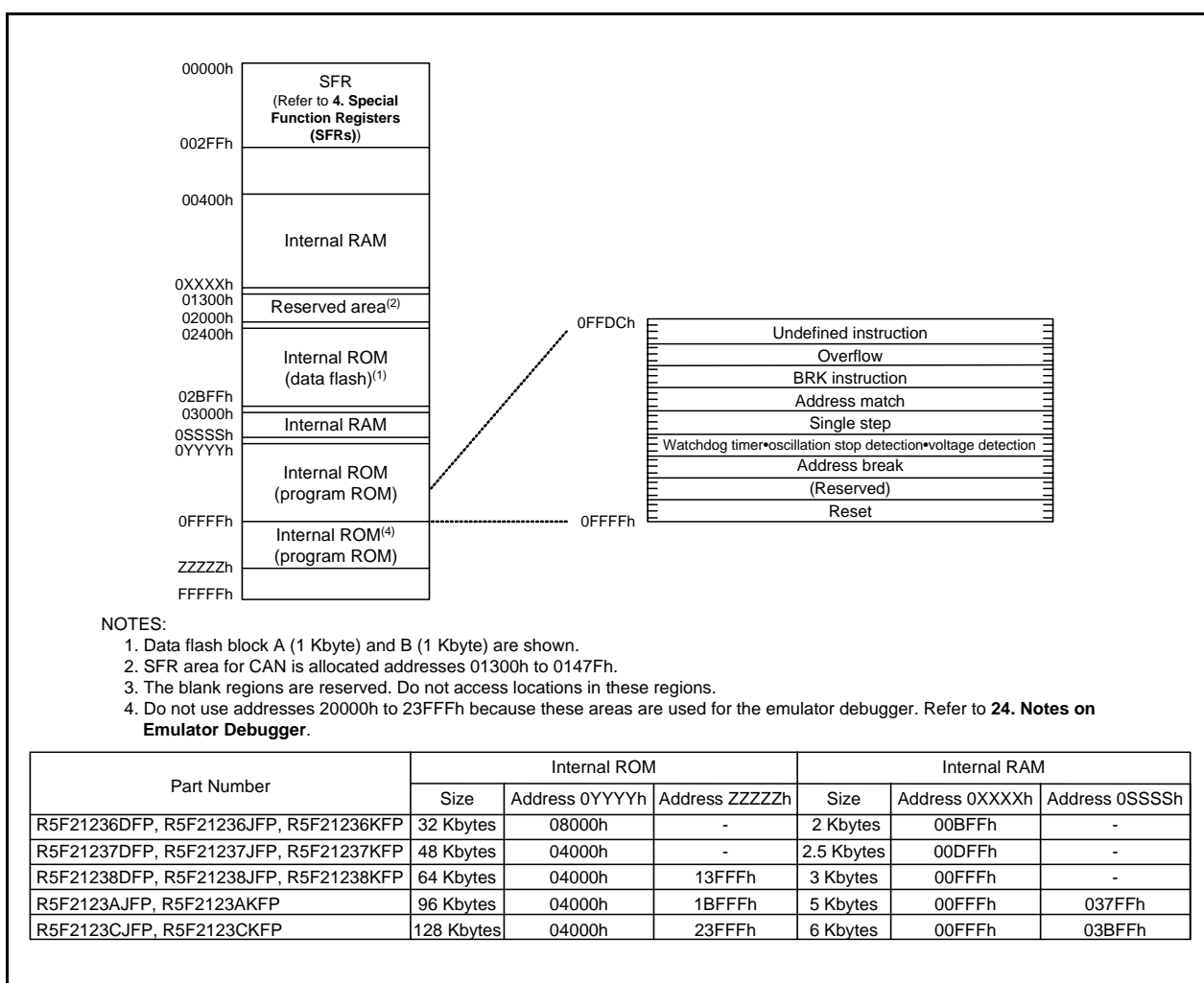


Figure 3.2 Memory Map of R8C/23 Group

## 4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function.

Table 4.1 to Table 4.13 list the SFR Information.

**Table 4.1 SFR Information (1)(1)**

Address	Register	Symbol	After reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			00h
0017h			00h
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protect Mode Register	CSPR	00h 10000000b <sup>(8)</sup>
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h			
0030h			
0031h	Voltage Detection Register 1 <sup>(2)</sup>	VCA1	00001000b
0032h	Voltage Detection Register 2 <sup>(6)</sup>	VCA2	00h <sup>(3)</sup> 01000000b <sup>(4)</sup>
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register <sup>(7)</sup>	VW1C	0000X000b <sup>(3)</sup> 0100X001b <sup>(4)</sup>
0037h	Voltage Monitor 2 Circuit Control Register <sup>(5)</sup>	VW2C	00h
0038h			
0039h			
003Fh			

X: Undefined

### NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect this register.
3. The LVD0ON bit in the OFS register is set to 1.
4. Power-on reset, voltage monitor 1 reset or the LVD0ON bit in the OFS register is set to 0.
5. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b2 and b3.
6. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b7.
7. Software reset, the watchdog timer reset, and the voltage monitor 2 reset do not affect other than the b0 and b6.
8. The CSPROINI bit in the OFS register is 0.

**Table 4.3 SFR Information (3)<sup>(1)</sup>**

Address	Register	Symbol	After reset
0080h			
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h			
0095h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh			XXh
00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ADh	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AFh			XXh
00B0h			
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h	SS Control Register H/IIC Bus Control Register 1 <sup>(2)</sup>	SSCRH/ICCR1	00h
00B9h	SS Control Register L/IIC Bus Control Register 2 <sup>(2)</sup>	SSCRL/ICCR2	01111101b
00BAh	SS Mode Register/IIC Bus Mode Register 1 <sup>(2)</sup>	SSMR/ICMR	00011000b
00BBh	SS Enable Register/IIC Bus Interrupt Enable Register <sup>(2)</sup>	SSER/ICIER	00h
00BCh	SS Status Register/IIC Bus Status Register <sup>(2)</sup>	SSSR/ICSR	00h/0000X000b
00BDh	SS Mode Register 2/Slave Address Register <sup>(2)</sup>	SSMR2/SAR	00h
00BEh	SS Transmit Data Register/IIC Bus Transmit Data Register <sup>(2)</sup>	SSTDR/ICDRT	FFh
00BFh	SS Receive Data Register/IIC Bus Receive Data Register <sup>(2)</sup>	SSRDR/ICDRR	FFh

X: Undefined

## NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. Selected by the IICSEL bit in the PMR register.

**Table 4.6 SFR Information (6)<sup>(1)</sup>**

Address	Register	Symbol	After reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h
0147h			00h
0148h	Timer RD General Register A0	TRDGRA0	FFh
0149h			FFh
014Ah	Timer RD General Register B0	TRDGRB0	FFh
014Bh			FFh
014Ch	Timer RD General Register C0	TRDGRC0	FFh
014Dh			FFh
014Eh	Timer RD General Register D0	TRDGRD0	FFh
014Fh			FFh
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	11000000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h
0157h			00h
0158h	Timer RD General Register A1	TRDGRA1	FFh
0159h			FFh
015Ah	Timer RD General Register B1	TRDGRB1	FFh
015Bh			FFh
015Ch	Timer RD General Register C1	TRDGRC1	FFh
015Dh			FFh
015Eh	Timer RD General Register D1	TRDGRD1	FFh
015Fh			FFh
0160h			
0161h			
0162h			
0163h			
0164h			
0165h			
0166h			
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017Fh			

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.



**Table 4.7 SFR Information (7)<sup>(1)</sup>**

Address	Register	Symbol	After reset
0180h			
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h			
0189h			
018Ah			
018Bh			
018Ch			
018Dh			
018Eh			
018Fh			
0190h			
0191h			
0192h			
0193h			
0194h			
0195h			
0196h			
0197h			
0198h			
0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACH			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h			
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B4h			
01B5h	Flash Memory Control Register 1	FMR1	1000000Xb
01B6h			
01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B8h			
01B9h			
01BAh			
01BBh			
01FDh			
01FEh			
01FFh			

X: Undefined

## NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

**Table 4.8 SFR Information (8)<sup>(1)</sup>**

Address	Register	Symbol	After reset
1300h	CAN0 Message Control Register 0	C0MCTL0	00h
1301h	CAN0 Message Control Register 1	C0MCTL1	00h
1302h	CAN0 Message Control Register 2	C0MCTL2	00h
1303h	CAN0 Message Control Register 3	C0MCTL3	00h
1304h	CAN0 Message Control Register 4	C0MCTL4	00h
1305h	CAN0 Message Control Register 5	C0MCTL5	00h
1306h	CAN0 Message Control Register 6	C0MCTL6	00h
1307h	CAN0 Message Control Register 7	C0MCTL7	00h
1308h	CAN0 Message Control Register 8	C0MCTL8	00h
1309h	CAN0 Message Control Register 9	C0MCTL9	00h
130Ah	CAN0 Message Control Register 10	C0MCTL10	00h
130Bh	CAN0 Message Control Register 11	C0MCTL11	00h
130Ch	CAN0 Message Control Register 12	C0MCTL12	00h
130Dh	CAN0 Message Control Register 13	C0MCTL13	00h
130Eh	CAN0 Message Control Register 14	C0MCTL14	00h
130Fh	CAN0 Message Control Register 15	C0MCTL15	00h
1310h	CAN0 Control Register	C0CTLR	X0000001b XX0X0000b
1311h			
1312h	CAN0 Status Register	C0STR	00h X0000001b
1313h			
1314h	CAN0 Slot Status Register	C0SSTR	00h 00h
1315h			
1316h	CAN0 Interrupt Control Register	C0ICR	00h 00h
1317h			
1318h	CAN0 Extended ID Register	C0IDR	00h 00h
1319h			
131Ah	CAN0 Configuration Register	C0CONR	XXh XXh
131Bh			
131Ch	CAN0 Receive Error Count Register	C0RECR	00h
131Dh	CAN0 Transmit Error Count Register	C0TECR	00h
131Eh			
131Fh			
1320h			
1321h			
1322h			
1323h			
1324h			
1325h			
1326h			
1327h			
1328h			
1329h			
132Ah			
132Bh			
132Ch			
132Dh			
132Eh			
132Fh			
1330h			
1331h			
1332h			
1333h			
1334h			
1335h			
1336h			
1337h			
1338h			
1339h			
133Ah			
133Bh			
133Ch			
133Dh			
133Eh			
133Fh			

X: Undefined

**NOTE:**

1. The blank regions are reserved. Do not access locations in these regions.

**Table 4.11 SFR Information (11)<sup>(1)</sup>**

Address	Register	Symbol	After reset
13C0h	CAN0 Slot 6: Identifier/DLC		XXh
13C1h			XXh
13C2h			XXh
13C3h			XXh
13C4h			XXh
13C5h			XXh
13C6h	CAN0 Slot 6: Data Field		XXh
13C7h			XXh
13C8h			XXh
13C9h			XXh
13CAh			XXh
13CBh			XXh
13CCh			XXh
13CDh			XXh
13CEh	CAN0 Slot 6: Time Stamp		XXh
13CFh			XXh
13D0h	CAN0 Slot 7: Identifier/DLC		XXh
13D1h			XXh
13D2h			XXh
13D3h			XXh
13D4h			XXh
13D5h			XXh
13D6h	CAN0 Slot 7: Data Field		XXh
13D7h			XXh
13D8h			XXh
13D9h			XXh
13DAh			XXh
13DBh			XXh
13DCh			XXh
13DDh			XXh
13DEh	CAN0 Slot 7: Time Stamp		XXh
13DFh			XXh
13E0h	CAN0 Slot 8: Identifier/DLC		XXh
13E1h			XXh
13E2h			XXh
13E3h			XXh
13E4h			XXh
13E5h			XXh
13E6h	CAN0 Slot 8: Data Field		XXh
13E7h			XXh
13E8h			XXh
13E9h			XXh
13EAh			XXh
13EBh			XXh
13ECh			XXh
13EDh			XXh
13EEh	CAN0 Slot 8: Time Stamp		XXh
13EFh			XXh
13F0h	CAN0 Slot 9: Identifier/DLC		XXh
13F1h			XXh
13F2h			XXh
13F3h			XXh
13F4h			XXh
13F5h			XXh
13F6h	CAN0 Slot 9: Data Field		XXh
13F7h			XXh
13F8h			XXh
13F9h			XXh
13FAh			XXh
13FBh			XXh
13FCh			XXh
13FDh			XXh
13FEh	CAN0 Slot 9: Time Stamp		XXh
13FFh			XXh

X: Undefined

## NOTE:

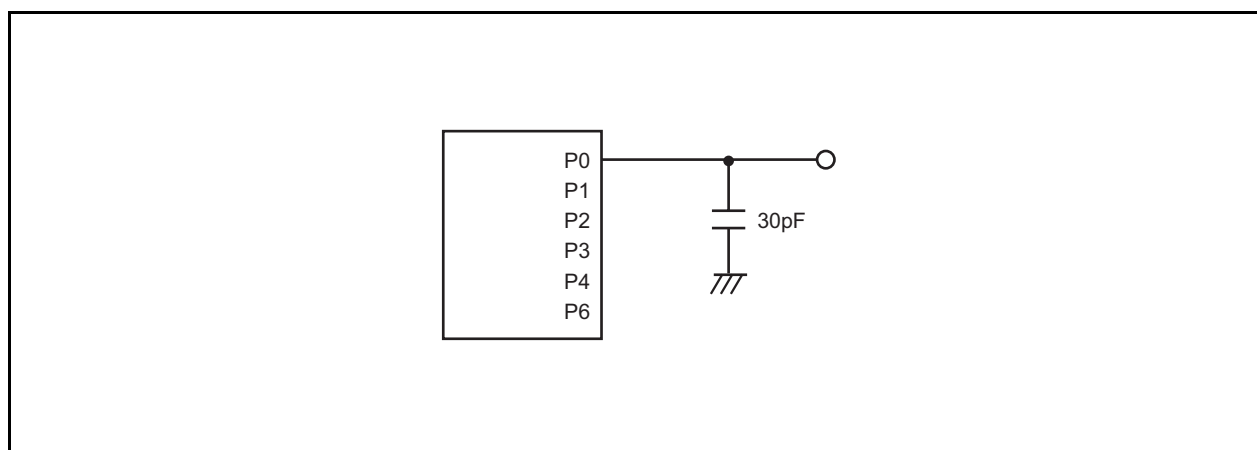
1. The blank regions are reserved. Do not access locations in these regions.

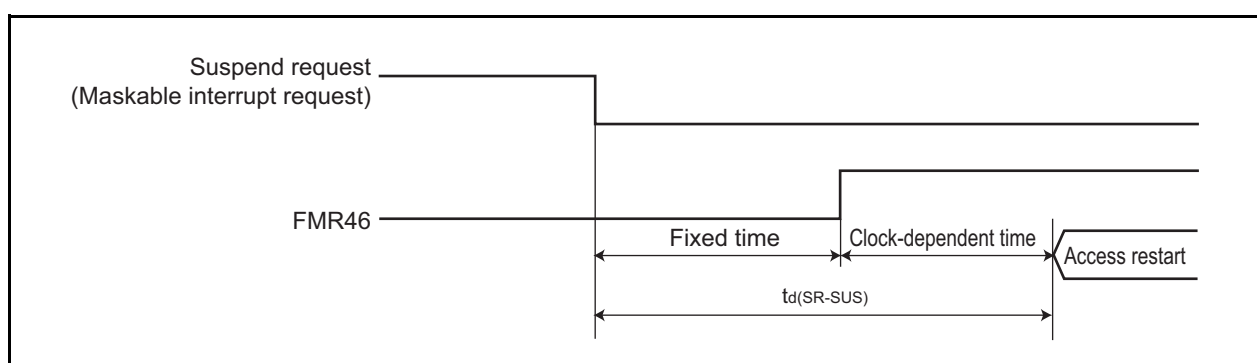
**Table 5.3 A/D Converter Characteristics**

Symbol	Parameter		Conditions	Standard			Unit
				Min.	Typ.	Max.	
—	Resolution		$V_{ref} = AV_{CC}$	—	—	10	Bits
—	Absolute Accuracy	10-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 5.0 \text{ V}$	—	—	$\pm 3$	LSB
		8-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 5.0 \text{ V}$	—	—	$\pm 2$	LSB
		10-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 3.3 \text{ V}$	—	—	$\pm 5$	LSB
		8-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 3.3 \text{ V}$	—	—	$\pm 2$	LSB
$R_{ladder}$	Resistor ladder		$V_{ref} = AV_{CC}$	10	—	40	$k\Omega$
$t_{conv}$	Conversion time	10-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 5.0 \text{ V}$	3.3	—	—	$\mu s$
		8-bit mode	$\phi AD = 10 \text{ MHz}$ , $V_{ref} = AV_{CC} = 5.0 \text{ V}$	2.8	—	—	$\mu s$
$V_{ref}$	Reference voltage			2.7	—	$AV_{CC}$	V
$V_{IA}$	Analog input voltage <sup>(2)</sup>			0	—	$AV_{CC}$	V
—	A/D operating clock frequency	Without sample & hold		0.25	—	10	MHz
		With sample & hold		1	—	10	MHz

## NOTES:

1.  $V_{CC} = AV_{CC} = 2.7$  to  $5.5 \text{ V}$  at  $T_{opr} = -40$  to  $85^\circ\text{C}$  (D, J version) /  $-40$  to  $125^\circ\text{C}$  (K version), unless otherwise specified.
2. When analog input voltage exceeds reference voltage, A/D conversion result is 3FFh in 10-bit mode, FFh in 8-bit mode.

**Figure 5.1 Ports P0 to P4, P6 Timing Measurement Circuit**

**Figure 5.2** Time delay until Suspend**Table 5.6** Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det1</sub>	Voltage detection level <sup>(3, 4)</sup>		2.70	2.85	3.00	V
t <sub>d</sub> (V <sub>det1</sub> -A)	Voltage monitor 1 reset generation time <sup>(5)</sup>		–	40	200	μs
–	Voltage detection circuit self power consumption	VCA26 = 1, V <sub>CC</sub> = 5.0 V	–	0.6	–	μA
t <sub>d</sub> (E-A)	Waiting time until voltage detection circuit operation starts <sup>(2)</sup>		–	–	100	μs
V <sub>ccmin</sub>	MCU operating voltage minimum value		2.70	–	–	V

## NOTES:

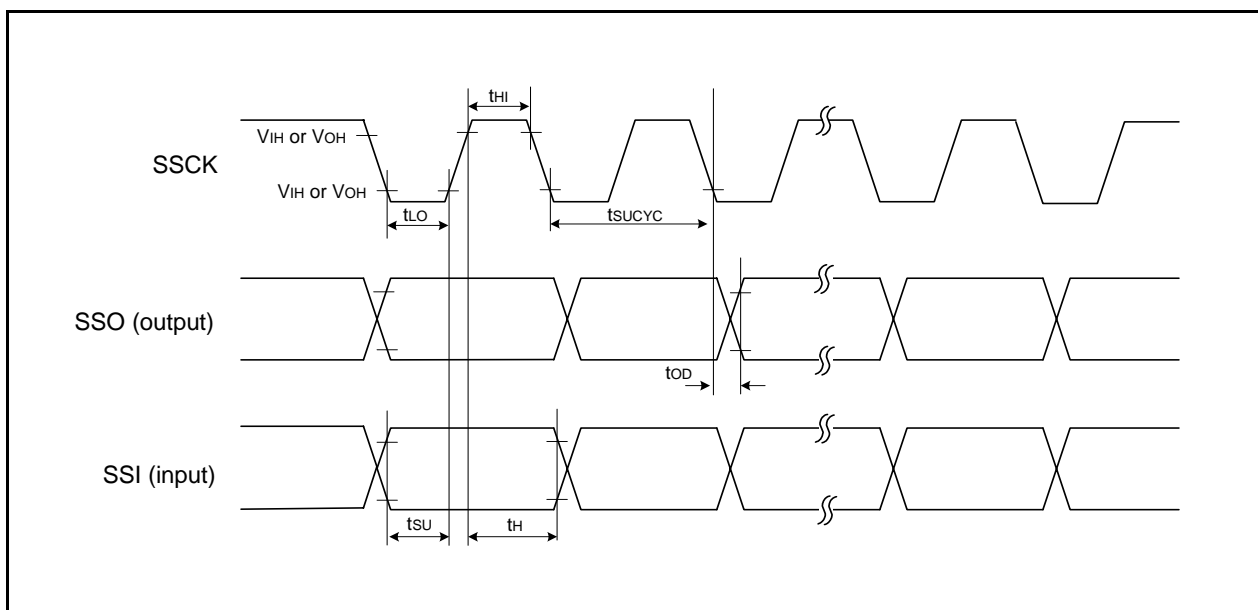
1. The measurement condition is V<sub>CC</sub> = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
3. Hold V<sub>det2</sub> > V<sub>det1</sub>.
4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.
5. Time until the voltage monitor 1 reset is generated after the voltage passes V<sub>det1</sub> when V<sub>CC</sub> falls. When using the digital filter, its sampling time is added to t<sub>d</sub>(V<sub>det1</sub>-A). When using the voltage monitor 1 reset, maintain this time until V<sub>CC</sub> = 2.0 V after the voltage passes V<sub>det1</sub> when the power supply falls.

**Table 5.7** Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det2</sub>	Voltage detection level <sup>(4)</sup>		3.3	3.6	3.9	V
t <sub>d</sub> (V <sub>det2</sub> -A)	Voltage monitor 2 reset/interrupt request generation time <sup>(2, 5)</sup>		–	40	200	μs
–	Voltage detection circuit self power consumption	VCA27 = 1, V <sub>CC</sub> = 5.0V	–	0.6	–	μA
t <sub>d</sub> (E-A)	Waiting time until voltage detection circuit operation starts <sup>(3)</sup>		–	–	100	μs

## NOTES:

1. The measurement condition is V<sub>CC</sub> = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
2. Time until the voltage monitor 2 reset/interrupt request is generated since the voltage passes V<sub>det2</sub>.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.
4. Hold V<sub>det2</sub> > V<sub>det1</sub>.
5. When using the digital filter, its sampling time is added to t<sub>d</sub>(V<sub>det2</sub>-A). When using the voltage monitor 2 reset, maintain this time until V<sub>CC</sub> = 2.0 V after the voltage passes V<sub>det2</sub> when the power supply falls.



**Figure 5.6 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Clock Synchronous Communication Mode)**

**Table 5.20 Electrical Characteristics (3) [Vcc = 3 V]**

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
VOH	Output "H" voltage	Except XOUT	IOH = -1 mA		Vcc - 0.5	—	Vcc	V
		XOUT	Drive capacity HIGH	IOH = -0.1 mA	Vcc - 0.5	—	Vcc	V
			Drive capacity LOW	IOH = -50 $\mu$ A	Vcc - 0.5	—	Vcc	V
VOL	Output "L" voltage	Except XOUT	IOL = 1 mA		—	—	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	—	—	0.5	V
			Drive capacity LOW	IOL = 50 $\mu$ A	—	—	0.5	V
VT+-VT-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.3	—	V
		RESET			0.1	0.4	—	V
IiH	Input "H" current		VI = 3 V, Vcc = 3 V		—	—	4.0	$\mu$ A
IiL	Input "L" current		VI = 0 V, Vcc = 3 V		—	—	-4.0	$\mu$ A
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3 V		66	160	500	k $\Omega$
RfXIN	Feedback resistance	XIN			—	3.0	—	M $\Omega$
VRAM	RAM hold voltage		During stop mode		2.0	—	—	V

## NOTE:

- Vcc = 2.7 to 3.3 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 10 MHz, unless otherwise specified.

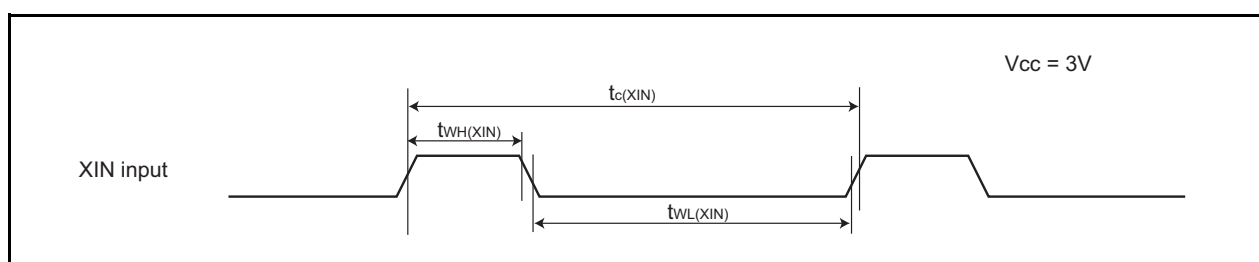
**Table 5.21 Electrical Characteristics (4) [V<sub>CC</sub> = 3 V]  
(T<sub>opr</sub> = -40 to 85°C (D, J version) / -40 to 125°C (K version), Unless Otherwise Specified.)**

Symbol	Parameter	Condition	Standard			Unit	
			Min.	Typ.	Max.		
Icc	Power supply current (Vcc = 2.7 to 3.3 V) In single-chip mode, the output pins are open and other pins are Vss	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	11.5	23.0	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	9.5	19.0	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	6.0	12.0	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	5.5	–	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	4.5	–	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	–	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	–	6.3	12.6	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.1	–	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	–	145	290	μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	–	56	112	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0	–	35	70	μA
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	–	0.7	3.0	μA
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	–	1.1	–	μA
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	–	3.8	–	μA

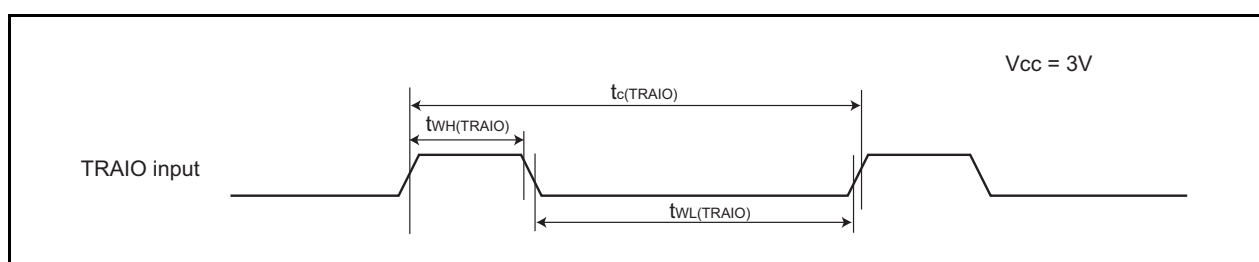


**Timing Requirements (Unless Otherwise Specified:  $V_{CC} = 3\text{ V}$ ,  $V_{SS} = 0\text{ V}$  at  $T_{opr} = 25^\circ\text{C}$ ) [ $V_{CC} = 3\text{ V}$ ]****Table 5.22 XIN Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XIN)}$	XIN input cycle time	100	—	ns
$t_{WH(XIN)}$	XIN input "H" width	40	—	ns
$t_{WL(XIN)}$	XIN input "L" width	40	—	ns

**Figure 5.12 XIN Input Timing Diagram when  $V_{CC} = 3\text{ V}$** **Table 5.23 TRAIO Input**

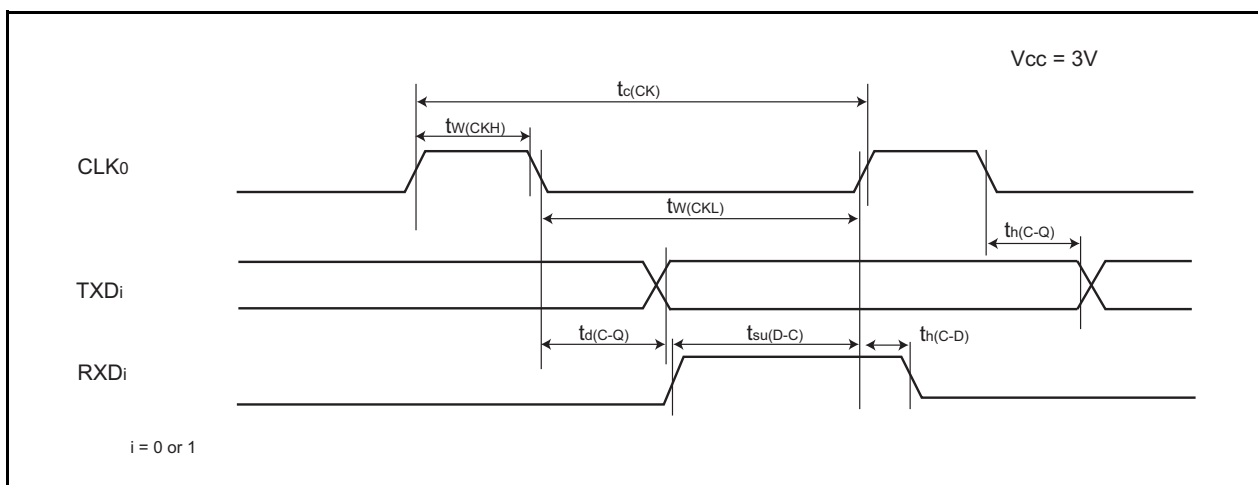
Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input Cycle time	300	—	ns
$t_{WH(TRAIO)}$	TRAIO input "H" width	120	—	ns
$t_{WL(TRAIO)}$	TRAIO input "L" width	120	—	ns

**Figure 5.13 TRAIO Input Timing Diagram when  $V_{CC} = 3\text{ V}$**

**Table 5.24 Serial Interface**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLK0 input cycle time	300	—	ns
$t_{w(CKH)}$	CLK0 input "H" width	150	—	ns
$t_{w(CKL)}$	CLK0 input "L" width	150	—	ns
$t_{d(C-Q)}$	TXDi output delay time	—	80	ns
$t_{h(C-Q)}$	TXDi hold time	0	—	ns
$t_{su(D-C)}$	RXD <sub>i</sub> input setup time	70	—	ns
$t_{h(C-D)}$	RXD <sub>i</sub> input hold time	90	—	ns

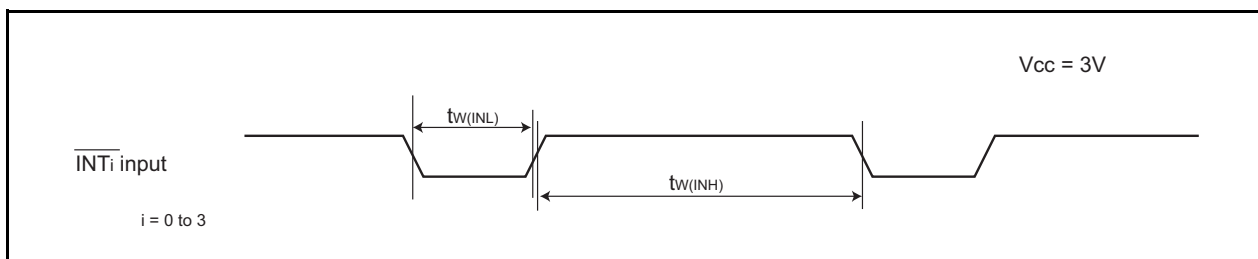
i = 0 or 1

**Figure 5.14 Serial Interface Timing Diagram when Vcc = 3 V****Table 5.25 External Interrupt  $\overline{INT_i}$  (i = 0 to 3) Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INT_i}$ input "H" width	380 <sup>(1)</sup>	—	ns
$t_{w(INL)}$	$\overline{INT_i}$ input "L" width	380 <sup>(2)</sup>	—	ns

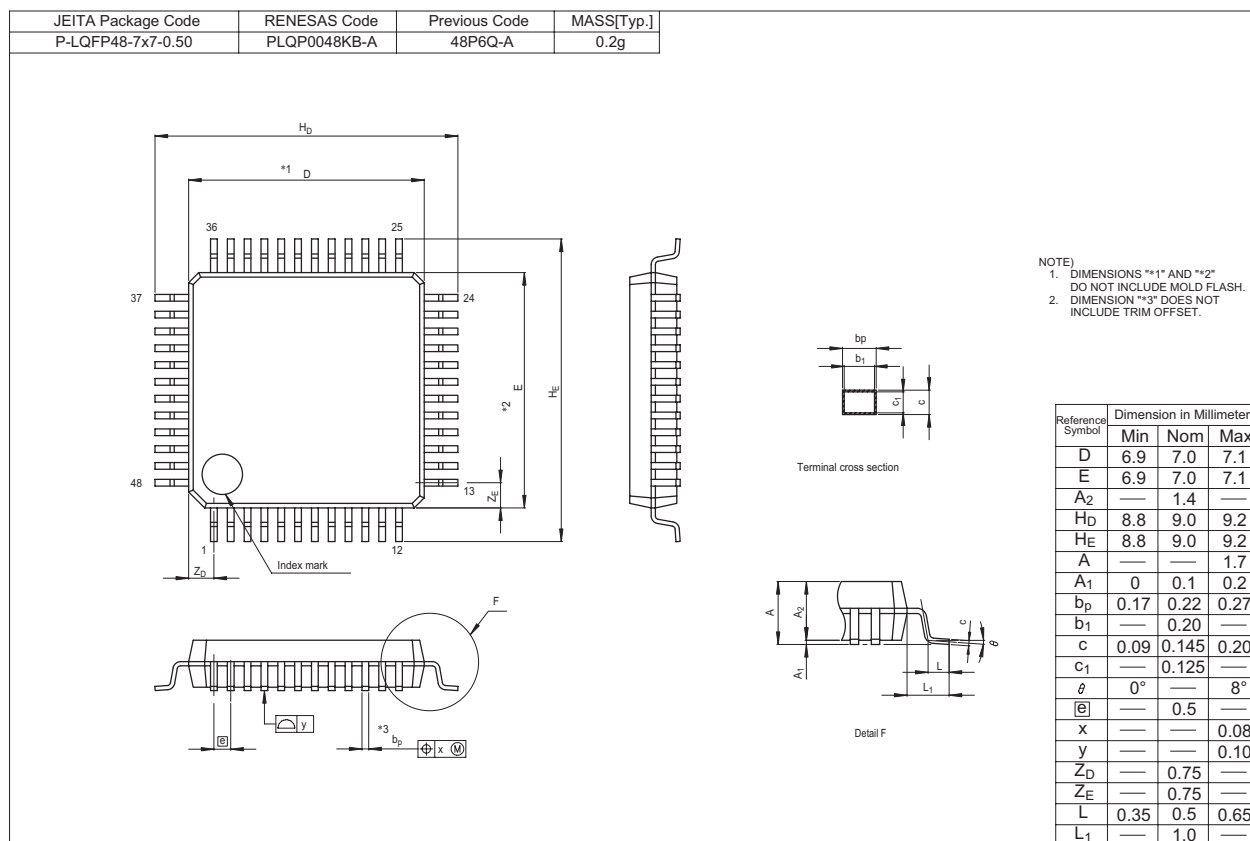
**NOTES:**

1. When selecting the digital filter by the  $\overline{INT_i}$  input filter select bit, use the  $\overline{INT_i}$  input HIGH width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.
2. When selecting the digital filter by the  $\overline{INT_i}$  input filter select bit, use the  $\overline{INT_i}$  input LOW width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.

**Figure 5.15 External Interrupt  $\overline{INT_i}$  Input Timing Diagram when Vcc = 3 V (i = 0 to 3)**

## Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the “Packages” section of the Renesas Technology website.



REVISION HISTORY	R8C/22 Group, R8C/23 Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.10	Mar 08, 2005	–	First Edition issued
0.20	Sep 29, 2005	–	Words standardized - Clock synchronous serial interface → Clock synchronous serial I/O - Chip-select clock synchronous interface(SSU) → Clock synchronous serial I/O with chip select - I <sup>2</sup> C bus interface(IIC) → I <sup>2</sup> C bus interface
		2, 3	Table1.1 R8C/22 Group Performance, Table1.2 R8C/23 Group Performance Serial Interface revised: - Clock Synchronous Serial Interface: 1 channel I <sup>2</sup> C bus Interface (3), Clock synchronous serial I/O with chip select - Power-On Reset Circuit added - Power Consumption value determined
		5, 6	Table 1.3 Product Information of R8C/22 Group, Table 1.4 Product Information of R8C/23 Group Date revised.
		7	Figure 1.4 Pin Assignment Pin name revised: - P3_5/SSCK(/SCL) → P3_5/ SCL/SSCK - P3_4/SCS(/SDA) → P3_4/ SDA /SCS - VSS → VSS/AVSS - VCC → VCC/AVCC - P1_5/RXD0/(TRAIO/INT1) → P1_5/RXD0/(TRAIO)/(INT1) - P6_6/INT2/(TXD1) → P6_6/INT2/TXD1 - P6_7/INT3/(RXD1) → P6_7/INT3/RXD1 - NOTE2 added
		8	Table 1.5 Pin Description - Analog Power Supply Input: line added - I <sup>2</sup> C Bus Interface (IIC) → I <sup>2</sup> C Bus Interface - SSU → Clock Synchronous Serial I/O with Chip Select
		9	Table 1.6 Pin Name Information by Pin Number revised - Pin Number 1: (SCL) → SCL - Pin Number 2: (SDA) → SDA - Pin Number 9: VSS → VSS/AVSS - Pin Number 11: VCC → VCC/AVCC - Pin Number 26: (TXD1) → TXD1 - Pin Number 27: (RXD1) → RXD1
		15	Table 4.1 SFR Information (1) revised - 0013h: XXXXX00b → 00h
		17	Table 4.3 SFR Information (3) revised - 00BCh: 0000X000b → 00h/0000X000b
		18	Table 4.4 SFR Information (4) revised - 00D6h: 00000XXXb → 00h - 00F5h: UART1 Function Select Register added
		19	Table 4.5 SFR Information (5) revised - 0104h: TRATR → TRA

Notes:

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